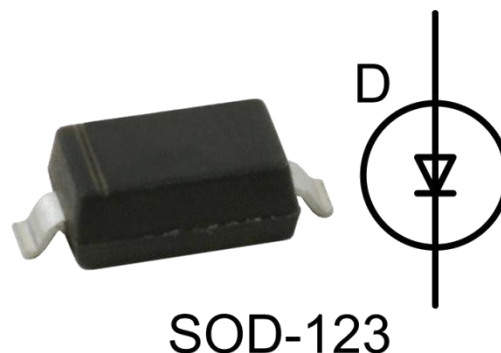


Spike Clamped Diode

General Features

- Silicon Epitaxial Planar Diode
- Highly Uniform V_{BR} ($\pm 7\%$) guaranteed by Specification
- Highly Uniform Current Distribution
- RoHS Compliant & Halogen Free



SOD-123

General Description

This novel diode, manufactured by ARK proprietary silicon process and structure, is featured with both highly uniform breakdown voltage (V_{BR}). It is suitable for the snubber circuit in various AC/DC power conversions system. The device can effectively relax the electrical stress on system and therefore improve reliability.

Applications

- Voltage Clamped circuit

Ordering Information

| Part Number | Package | Marking |
|-------------|---------|---------|
| SCD120S | SOD-123 | D12S |

Absolute Maximum Ratings

$T_A=25^\circ\text{C}$ unless otherwise specified

| Symbol | Parameter | Value | Unit |
|-----------|---|-------|------|
| P_{tot} | Power dissipation @ $T_A=25^\circ\text{C}$ | 0.5 | W |
| | Power dissipation @ $T_L=85^\circ\text{C}$ | 2.0 | W |
| P_{ZSM} | Non-repetitive peak pulse power dissipation | 300 | W |

Thermal Characteristics

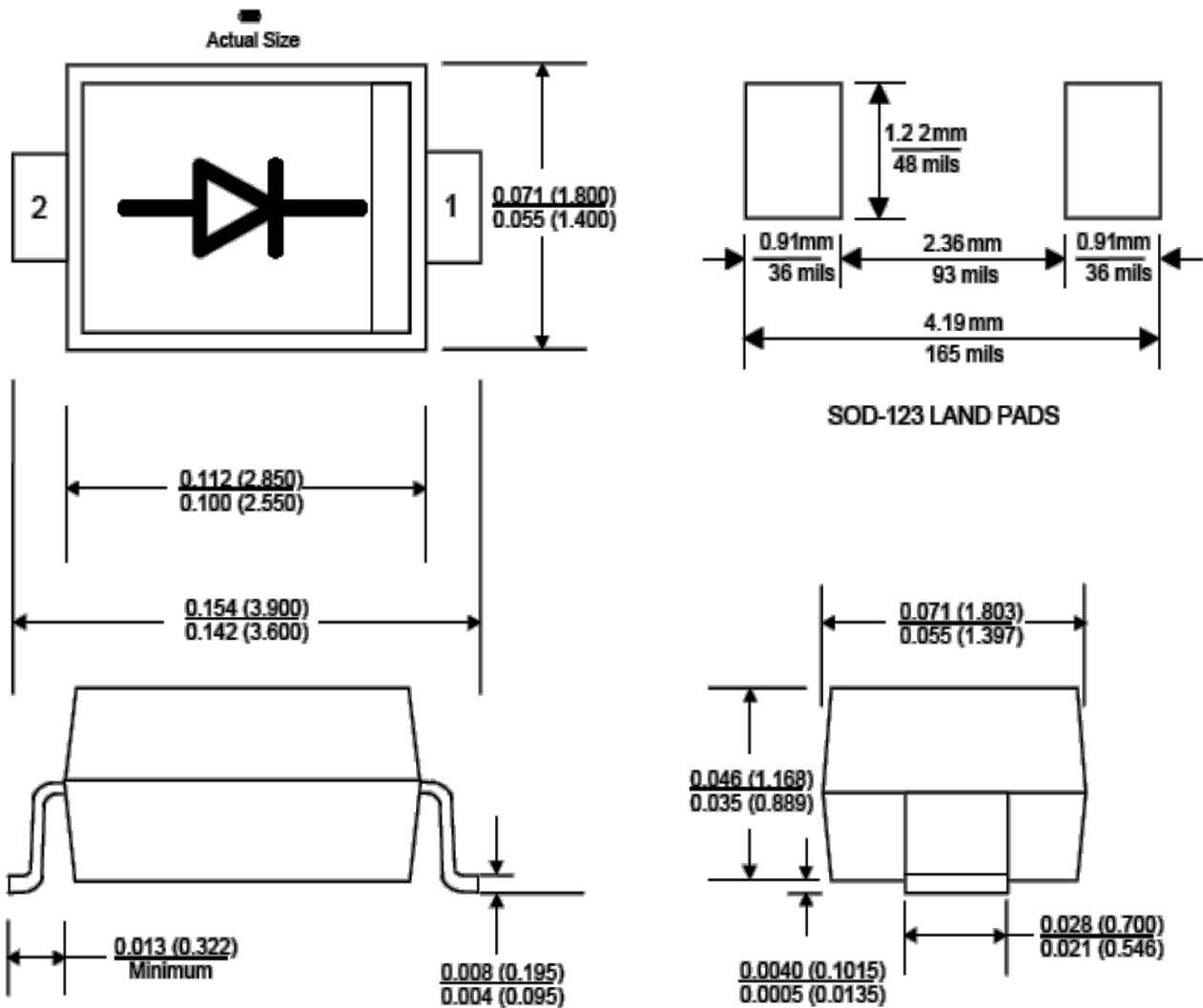
$T_A=25^\circ\text{C}$ unless otherwise specified

| Symbol | Parameter | Value | Unit |
|------------|--|-------------|------------------|
| R_{thJA} | Junction-to-Ambient thermal resistance | 300 | K/W |
| T_j | Junction temperature | 175 | $^\circ\text{C}$ |
| T_{stg} | Storage temperature range | -65 to +175 | $^\circ\text{C}$ |

Electrical Characteristics
 $T_A = 25^\circ\text{C}$ unless otherwise specified

| Symbol | Parameter | Min. | Typ. | Max. | Unit | Test Conditions |
|-------------------------|---|------|------|------|---------------------------|---|
| V_F | Forward Voltage | -- | -- | 1.2 | V | $I_F=10\text{mA}$ |
| I_R | Reverse Current | -- | -- | 25 | nA | $V_R=25\text{V}$ |
| | | -- | -- | 100 | nA | $V_R=96\text{V}$ |
| V_R | Reverse Breakdown Voltage | 112 | 120 | 128 | V | $I_R = 2\text{mA}\sim 5\text{mA}$ |
| $\Delta V_R/\Delta T_J$ | Breakdown Voltage Temperature coefficient | -- | 1.2 | -- | $\text{V}/^\circ\text{C}$ | Reference to $T_A=25^\circ\text{C}$ |
| t_{rr} | Reverse recovery time | -- | 63 | -- | ns | $I_F=100\text{mA}$ $di/dt = 10\text{A}/\mu\text{s}$ $V_R=6\text{V}$ |
| Q _{rr} | Reverse recovery charge | -- | 21 | -- | nC | |
| I _{rrm} | Peak reverse recovery current | -- | 670 | -- | mA | |

Package Dimensions





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